

### IRLI2910PBF-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>(BR)DSS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)		
100	0.034 at V <sub>GS</sub> = 10 V	50 <sup>a</sup>		

### FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R<sub>g</sub> Tested

#### **APPLICATIONS**

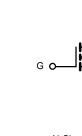
• Isolated DC/DC Converters

D





GDS



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>C</sub> = 25 °C, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	100	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	- V
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C	L.	50 <sup>a</sup>	
	T <sub>C</sub> = 125 °C	I <sub>D</sub>	28 <sup>a</sup>	
Pulsed Drain Current		I <sub>DM</sub>	120	A
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	31	
Single Pulse Avalanche Energy <sup>b</sup>	L = 0.11111	E <sub>AS</sub>	61	mJ
	T <sub>C</sub> = 25 °C	P	360 <sup>c</sup>	14/
Maximum Power Dissipation <sup>b</sup>	T <sub>A</sub> = 25 °C <sup>d</sup>	– P <sub>D</sub> –	3.70	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) <sup>d</sup>	R <sub>thJA</sub>	40	°C/W	
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.4	C/W	

Notes:

- a. Package limited.
- b. Duty cycle  $\leq$  1 %.
- c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

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					www.V	/Bsemi.	
<b>SPECIFICATIONS</b> $T_J = 25^{\circ}$	C, unless o	therwise noted					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 V, I_{D} = 250 \mu A$	100			V	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.5		2.5	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μA	
		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250	l	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А	
	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.034		Ω	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C		0.063			
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C		0.084			
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	25			S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz		5100			
Output Capacitance	C <sub>oss</sub>			480		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			210			
Total Gate Charge <sup>c</sup>	Qg	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 65 A		90	130	nC	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>			23			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			34			
Gate Resistance	Rg		0.5	1.7	3.3	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			24	35		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$		220	330	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 65 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_{g} = 2.5 \Omega$		45	70		
Fall Time <sup>c</sup>	t <sub>f</sub>	9		200	300		
Source-Drain Diode Ratings and Cha		$\Gamma_{\rm C} = 25 ^{\circ}{\rm C}^{\rm b}$					
Continuous Current	Is			50		A	
Pulsed Current	I <sub>SM</sub>			120			
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 65 A, V <sub>GS</sub> = 0 V		1.0	1.5	V	
Reverse Recovery Time	t <sub>rr</sub>	+		130	200	ns	
	۲r	4		130	200	115	

 $I_F = 50 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ 

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

I<sub>RM(REC)</sub>

 $\mathsf{Q}_{\mathsf{rr}}$ 

c. Independent of operating temperature.

Peak Reverse Recovery Current

Reverse Recovery Charge

8

0.52

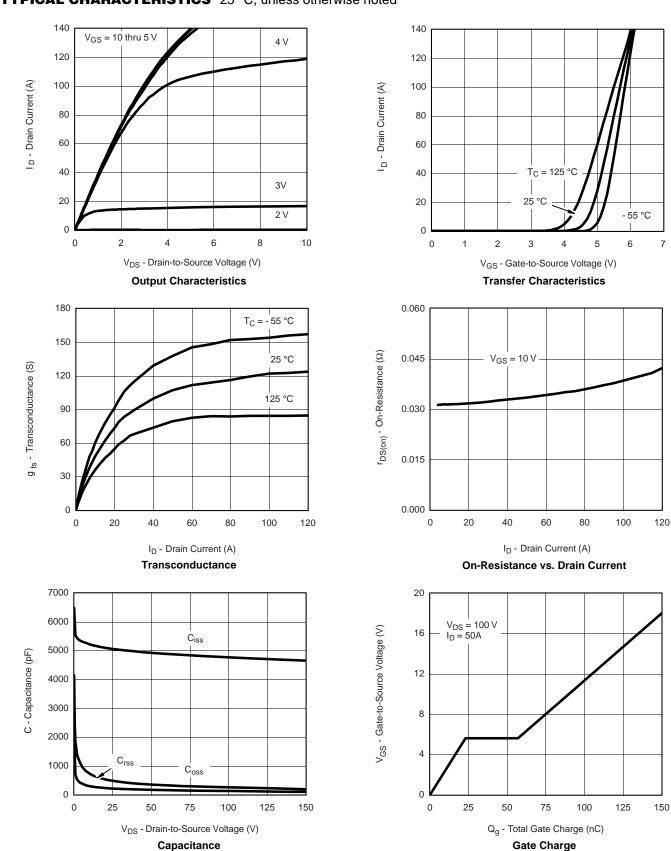
12

1.2

А

μC

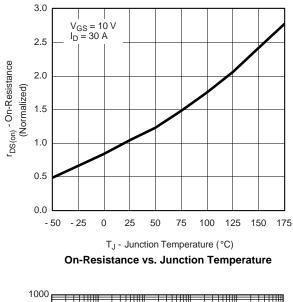


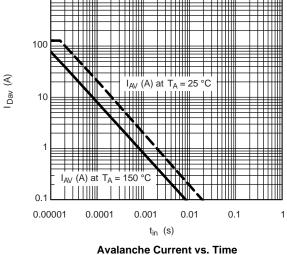


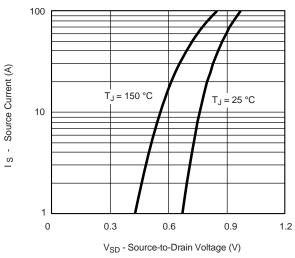
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



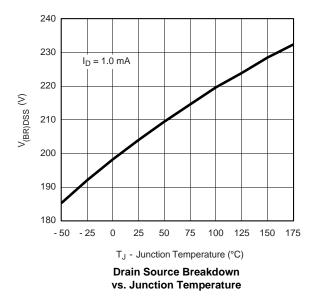
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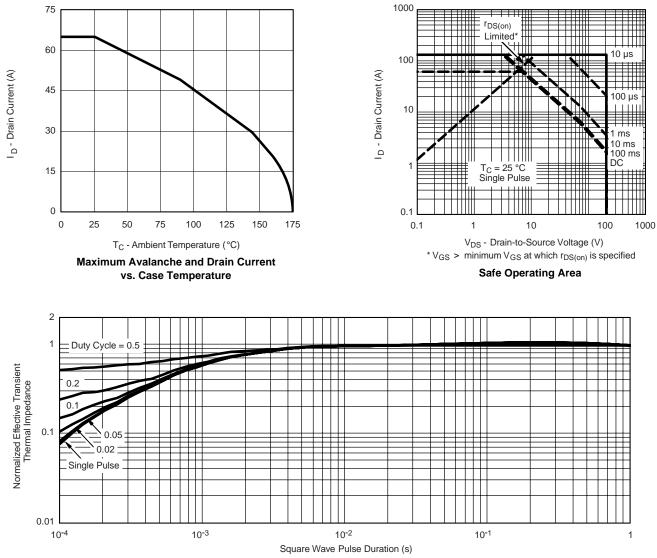
Source-Drain Diode Forward Voltage



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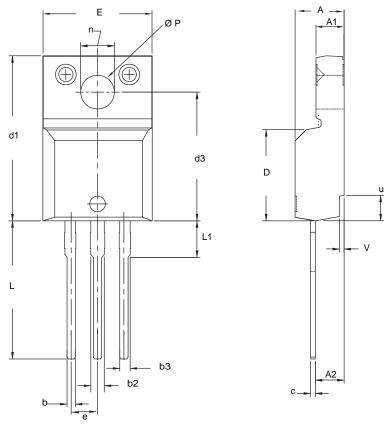
#### **THERMAL RATINGS**



Normalized Thermal Transient Impedance, Junction-to-Case



### **TO-220 FULLPAK (HIGH VOLTAGE)**



MIN.     4.570     2.570     2.510     0.622     1.229     1.229     0.440     8.650     15.88	MAX.     4.830     2.830     2.850     0.890     1.400     0.629     9.800	MIN.     0.180     0.101     0.099     0.024     0.048     0.048     0.017     0.341	MAX. 0.190 0.111 0.112 0.035 0.055 0.055 0.055 0.025 0.386
2.570 2.510 0.622 1.229 1.229 0.440 8.650	2.830 2.850 0.890 1.400 1.400 0.629 9.800	0.101 0.099 0.024 0.048 0.048 0.048	0.111 0.112 0.035 0.055 0.055 0.055 0.025
2.510 0.622 1.229 1.229 0.440 8.650	2.850 0.890 1.400 1.400 0.629 9.800	0.099 0.024 0.048 0.048 0.017	0.112 0.035 0.055 0.055 0.025
0.622 1.229 1.229 0.440 8.650	0.890 1.400 1.400 0.629 9.800	0.024 0.048 0.048 0.017	0.035 0.055 0.055 0.025
1.229   1.229   0.440   8.650	1.400 1.400 0.629 9.800	0.048 0.048 0.017	0.055 0.055 0.025
1.229 0.440 8.650	1.400 0.629 9.800	0.048 0.017	0.055 0.025
0.440 8.650	0.629 9.800	0.017	0.025
8.650	9.800		
		0.341	0.386
15.88	16 100		0.000
	16.120	0.622	0.635
12.300	12.920	0.484	0.509
10.360	10.630	0.408	0.419
2.54 BSC		0.100	BSC
13.200	13.730	0.520	0.541
3.100	3.500	0.122	0.138
6.050	6.150	0.238	0.242
3.050	3.450	0.120	0.136
2.400	2.500	0.094	0.098
0.400	0.500	0.016	0.020
	10.360 2.54 13.200 3.100 6.050 3.050 2.400	10.360   10.630     2.54 BSC   13.730     3.100   3.500     6.050   6.150     3.050   3.450     2.400   2.500	10.360   10.630   0.408     2.54 BSC   0.100     13.200   13.730   0.520     3.100   3.500   0.122     6.050   6.150   0.238     3.050   3.450   0.120     2.400   2.500   0.094

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet  $C_{pk} > 1.33$ . 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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